A Brighter Solution

AMP DISPLAY INC.

SPECIFICATIONS

5.7-in COLOR TFT MODULE (350 Nits)

CUSTOMER:	
CUSTOMER PART NO.	
AMP DISPLAY PART NO.	A M - 3 2 0 2 4 0 N S T N Q W - W 0 H
APPROVED BY:	
DATE:	

☐ APPROVED FOR SPECIFICATIONS

☐ APPROVED FOR SPECIFICATION AND PROTOTYPES

AMP DISPLAY INC

9856 SIXTH STREET RANCHO CUCAMONGA CA 91730

TEL: 909-980-13410 FAX: 909-980-1419

WWW.AMPDISPLAY.COM

RECORD OF REVISION

Revision Date	Page	Contents	Editor
2007/8/9	-	New Release	Sunglin

1 Features

5.7 inch Amorphous-TFT-LCD (Thin Film Transistor Liquid Crystal Display) module. This module is composed of a 5.7" TFT-LCD panel, LCD controller, power driver circuit and backlight unit.

1.1 TFT Panel Feature :

(1) Construction: 5.7" a-Si color TFT-LCD, White LED / CCFL Backlight and PCB.
(2) Resolution (pixel): 320(R.G.B) X240
(3) Number of the Colors : 262K colors (R , G , B 6 bit digital each)
(4) LCD type : Transmissive Color TFT LCD (normally White)
(5) Interface: 54 pin pitch 0.5 FFC
(6) Power Supply Voltage: 3.3V single power input. Built-in power supply circuit.
(7) Viewing Direction:12 O'clock (The direction it's hard to be discolored):

1.2 LCD Controller Feature:

(1) MCU interface 8/9/16/18 bit 80&68 series MCU interface.
(2) Display RAM size : 640x240x3x6 bits. Ex:320x240 two frame buffer with 262K colors.
(3) Arbitrary display memory start position selection.
(4) MCU interface : 16 bit 80 MPU interface.
(5) 8 bit / 16 bit interface support 65K (R5G6B5) /262K(R6G6B6) colors data format.
(6) 9 bit / 18 bit interface support 262K(R6G6B6) colors data format only.

2 Physical specifications

Item	Specifications	Unit	
Display resolution(dot)	960 (W) x 240(H)	Mm	
Active area	115.2 (W) x 86.4 (H)	Mm	
Screen size	5.7(Diagonal)	Mm	
Pixel size	120 (W) x 360 (H)	Um	
Color configuration	R.G.B stripe		
Overall dimension	144.0(W)x104.6(H)x13.0(D)	Mm	
Weight	T.B.D	Mg	
Backlight unit	LED		

3 Default Setting & Option

- Interface :

The user can select the MCU interface by change the Jumper & Resister Array.

Setting / Interface Type	JP1	RA1	RA2	RA3	RA4	Remark
80-18Bit interface	1,2 short 2,3 open	2K ohm	OPEN	OPEN	OPEN	
80-16Bit interface	**1,2 short 2,3 open**	**OPEN**	**2K ohm**	**OPEN**	**OPEN**	**Default**
80-9Bit interface	1,2 short 2,3 open	OPEN	OPEN	2K ohm	OPEN	
80-8Bit interface	1,2 short 2,3 open	OPEN	OPEN	OPEN	2K ohm	
68-18Bit interface	1,2 open 2,3 short	2K ohm	OPEN	OPEN	OPEN	
68-16Bit interface	1,2 open 2,3 short	OPEN	2K ohm	OPEN	OPEN	
68-9Bit interface	1,2 open 2,3 short	OPEN	OPEN	2K ohm	OPEN	
68-8Bit interface	1,2 open 2,3 short	OPEN	OPEN	OPEN	2K ohm	

- Connector

33Pin Pin Header (Pitch 0.5 x 33 pin)		80/68 8/9/16/18 bit interface	Defaul

4 Electrical specification

4.1 Absolute max. ratings

4.1.1 Electrical Absolute max. ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power voltage	VDD	VSS=0	-0.3	5.5	V	
Input voltege	V_{in}		-0.3	VDD+0.3	V	Note 1

Note1: /CS,/WR,/RD,RS,DB0~DB7

4.1.2 Environmental Absolute max. ratings

Item	OPERATING		STORAGE		Remark
	MIN	MAX	MIN	MAX	
Temperature	-20	70	-30	80	Note2,3,4,5,6,7
Humidity	Note1		Note1		
Corrosive Gas	Not Acceptable		Not Acceptable		

Note1 : Ta <= 40℃ : 85% RH max

Ta > 40℃ : Absolute humidity must be lower than the humidity of 85%RH at 40℃

Note2 : For storage condition Ta at -30℃ < 48h , at 80℃ < 100h

For operating condition Ta at -20℃ < 100h

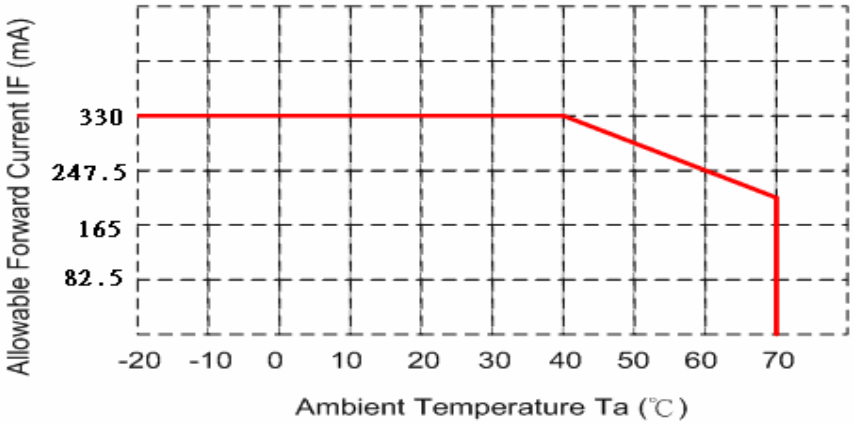
Note3 : Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note4 : The response time will be slower at low temperature.

Note5 : Only operation is guarantied at operating temperature. Contrast , response time, another display quality are evaluated at +25℃

Note6 :

- LED BL : When LCM is operated over 40℃ ambient temperature, the I_{LED} of the LED back-light should be follow :



Note7 : This is panel surface temperature, not ambient temperature.
Note8 :

- LED BL:When LCM be operated over than 40℃ , the life time of the LED back-light will be reduced.

4.1.3 LED back-light Unit Absolute max. ratings

Item	Symbol	Ratings	Unit	Remark
Peak forward Current	IF	360	mA	
Reverse Voltage	VR	12	V	
Power Dissipation	Po	4.32	W	

4.2 Electrical characteristics

4.2.1 DC Electrical characteristic of the LCD

Typical operting conditions (VSS=0V)

Item		Symbol	Min.	Typ.	Max.	Unit	Remark
Power supply		VDD	3.1	5.0	5.2	V	
Input Voltage for logic	H Level	V_{IH}	2.0	-	5.5	V	Note 1
	L Level	V_{IL}	VSS	-	0.8	V	
Output Voltage for Logic	H Level	V_{OH}	2.4	-	VDD	V	Note 2
	L Level	V_{OL}	VSS		0.4	V	
Power Supply current		IDD	-	150	-	mA	Note 3

Note1: With 5V Tolerance Input , /CS, /WR,/RD,RS,DB0~DB17

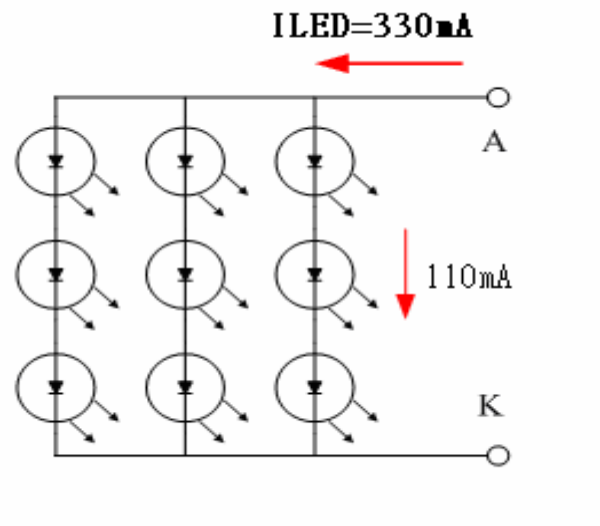
Note2: DB0~DB17

Note3: fv =60Hz , Ta=25℃ , VDD=3.3V , DCLK=10MHz, PLL frequency=40MHz,

Display pattern : All Black

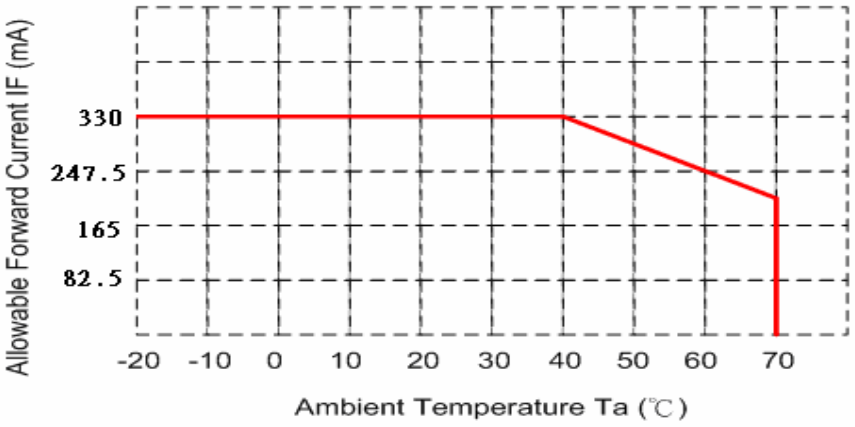
4.2.2 Electrical characteristic of LED Back-light

Paramenter	Symbol	Min.	Typ.	Max.	Unit	Condiction
LED voltage	V_{AK}	--	10.5	12	V	I_{LED} =140mA,Ta=25℃
LED forward current	I_{LED}	--	330	360	mA	Ta=25℃
	I_{LED}	--	210	240	mA	Ta=60℃
Lamp life time		30,000	-	-	Hr	I_{LED} =126mA,Ta=25℃



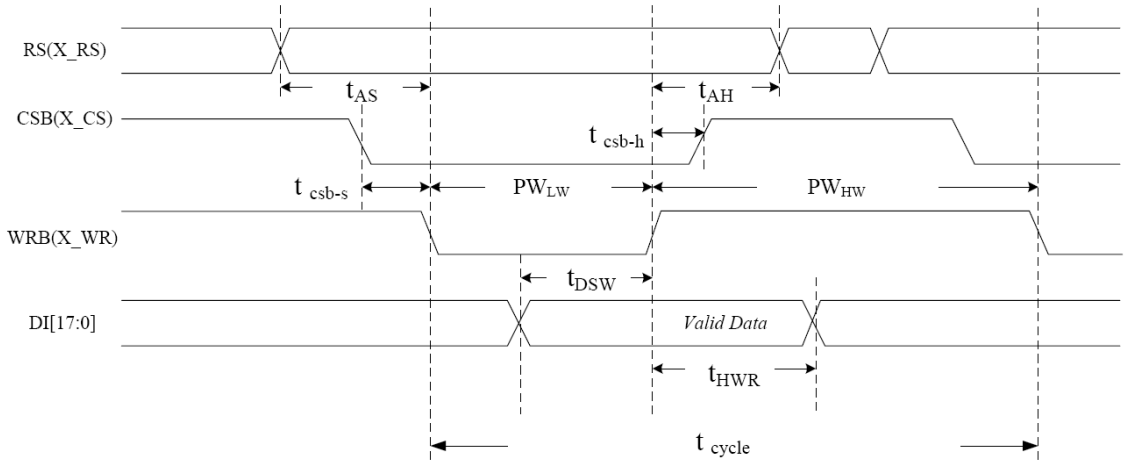
- The constant current source is needed for white LED back-light driving.

When LCM is operated over 60℃ ambient temperature, the I_{LED} of the LED back-light should be adjusted to 240mA max



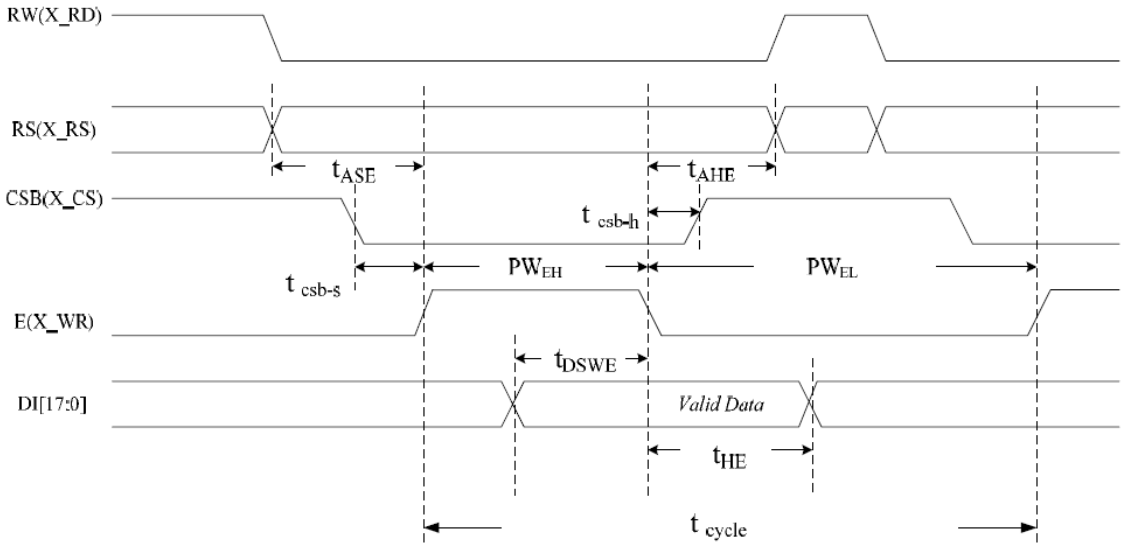
3.3 AC Timing characteristic of the Graphic TFT LCD controller

4.3 80 series Timing



Symbol	Parameter	Min	Typ	Max	Unit	Remark
t_{cycle}	Enable cycle time	100	200		ns	
PW_{HW}	Enable high-level pulse width	66	70		ns	
PW_{LW}	Enable low-level pulse width	33	130		ns	
t_{AS}	RS setup time	16	25		ns	
t_{AH}	RS hold time	16	45		ns	
t_{DSW}	Write data setup time	50	50		ns	
t_{HWR}	Write data hold time	50	40		ns	
t_{csb-s}	CSB setup time	16	20		ns	
t_{csb-h}	CSB hold time	16	30		ns	

4.4 68eries Timing



Symbol	Parameter	Min	Typ	Max	Unit	Remark
t_{cycle}	Enable cycle time	100	200		ns	
PW_{EH}	Enable high-level pulse width	66	70		ns	
PW_{EL}	Enable low level pulse width	33	130		ns	
t_{ASE}	RS setup time	16	25		ns	
t_{AHE}	RS hold time	16	45		ns	
t_{DSWE}	Write data setup time	50	50		ns	
t_{HE}	Write data hold time	50	40		ns	
t_{csb-s}	CSB setup time	16	20		ns	
t_{csbh}	CSB hold time	16	30		ns	

5 Optical specification

5.1 Optical characteristic :

Item		Symbol	Conditon	Min.	Typ.	Max.	Unit	Remark
Response Time	Rise Fall	T_r T_f	Θ=0°	- -	15 35	30 50	ms ms	Note 1,2,3,5
Contrast ratio		CR	At optimized viewing angle	200	350	-		Note 1,2,4,5
Viewing Angle	Top Bottom Left Right		CR≧10	55 45 55 55	60 50 60 60	- - - -	deg.	Note1,2, 5,6
Brightness LED BL			I_{LED}=330mA, 25℃	475	500	-	cd/m²	
Red chromaticity		X_R	Θ=0° Θ=0°	0.610	0.640	0.670		Note 7 For reference only. These data should be update according the prototype.
		Y_R		0.314	0.344	0.374		
Green chromaticity		X_G		0.268	0.298	0.328		
		Y_G		0.553	0.583	0.613		
Blue chromaticity		X_B		0.102	0.132	0.162		
		Y_B		0.107	0.137	0.167		
White chromaticity		X_W		0.282	0.312	0.342		
		Y_W		0.299	0.329	0.359		

( )For reference only. These data should be update according the prototype.

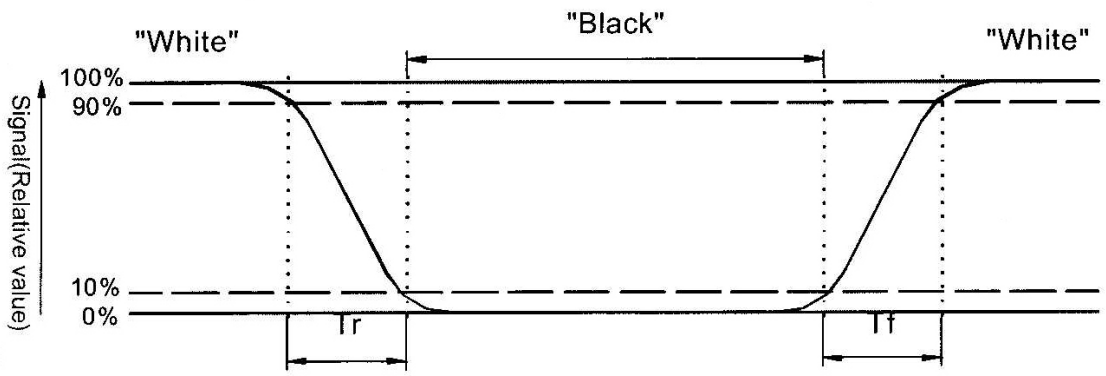
Note 1:

- LED BL :Ambient temperature=25℃,and lamp current I_{LED}=330mA.To be measured in the dark room.
- CCFL BL: Ambient temperature=25℃,and lamp current I_L=6 mArms.To be measured in the dark room.

Note 2:To be measured on the center area of panel with a viewing cone of 1°by Topcon luminance meter BM-7,after 10 minutes operation.

Note 3.Definition of response time:

The output signals of photo detector are measured when the input signals are changed from “black“ to “white”(falling time) and from”white” to “black” (rising time),respectively.The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



Note 4.Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio(CR)} = \frac{\text{Photo detector output when LCD is at "White" state}}{\text{Photo detector Output when LCD is at "Black" state}}$$

Note 5:White $V_i=V_{i50}$ +1.5V

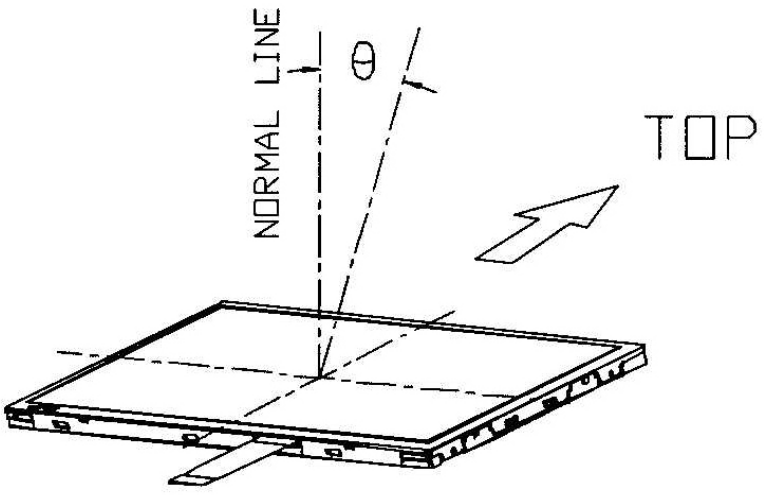
Black $V_i=V_{i50}$ +2.0V

"±"means that the analog input signal swings in phase with V_{COM} signal.

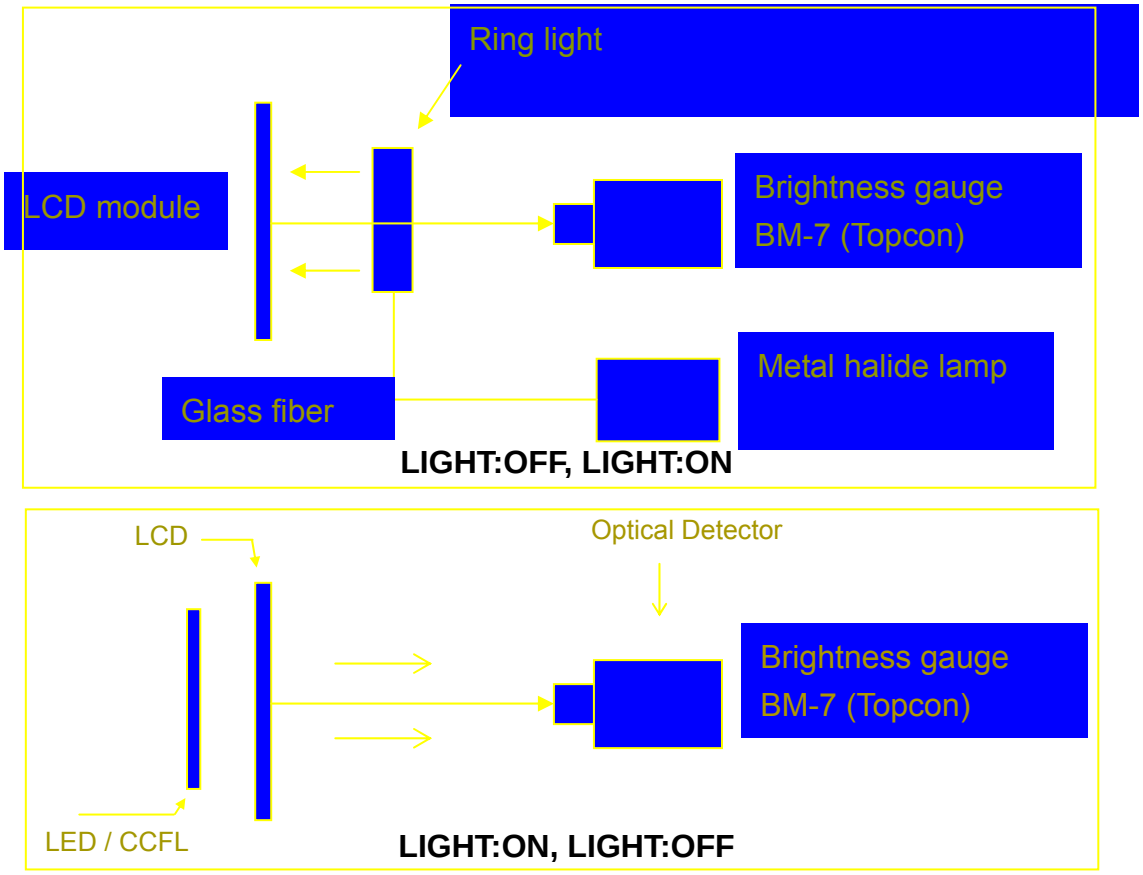
"$\frac{-}{+}$ " means that the analog input signal swings out of phase with V_{COM} signal.

V_{i50} : The analog input voltage when transmission is 50%.The 100% Transmission is defined as the transmission of LCD panel when all the Input terminals of module are electrically opened.

Note 6.Definition of viewing angle,Refer to figure as below.



Note 7.Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.



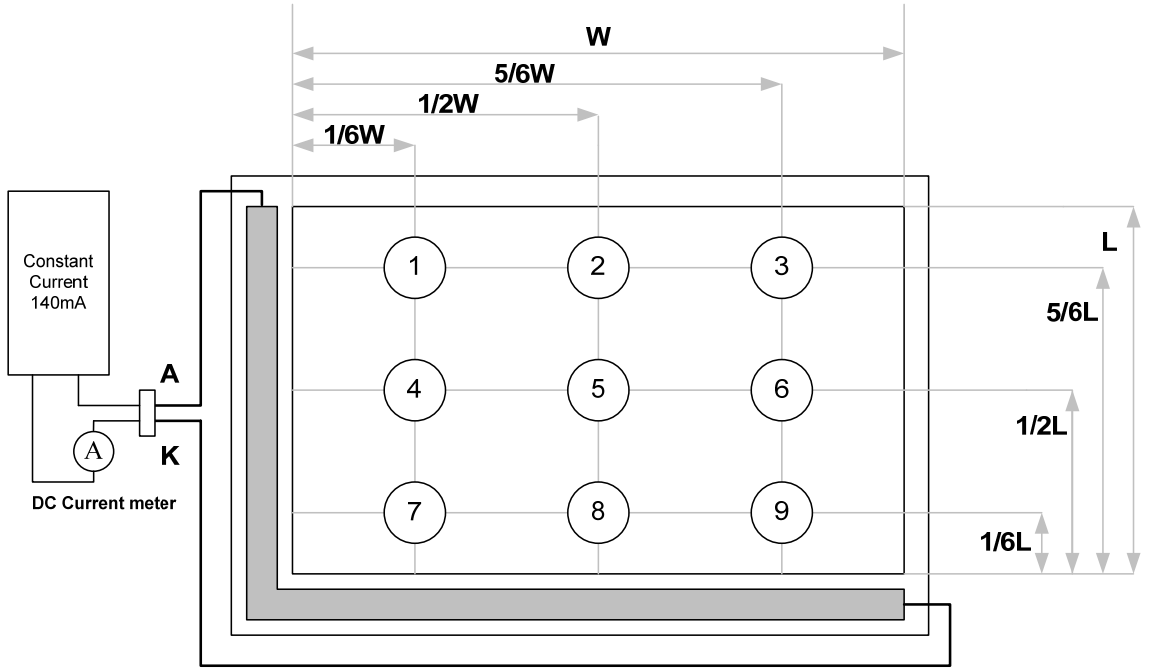
5.2 Optical characteristic of the LED Back-light

ITEM	MIN	TYP	MAX	UNIT	Condition
Bare Brightness	--	7000	--	Cd/m2	I_{LED} =330mA,Ta=25℃
AVG. X of 1931 C.I.E.	0.28	0.31	0.34	--	I_{LED} =330mA,Ta=25℃
AVG. X of 1931 C.I.E.	0.28	0.31	0.34	--	I_{LED} =330mA,Ta=25℃
Brightness Uniformity	80	--	--	%	I_{LED} =330mA,Ta=25℃

( )For reference only. These data should be update according the prototype.

Note1 : Measurement after 10 minutes from LED BL operating.

Note2 : Measurement of the following 9 places on the display.



Note3: The Uniformity definition

(Min Brightness / Max Brightness) x 100%

5.3 Touch Panel Electrical Specification

Parameter	Condition	Standard Value
Terminal Resistance	X Axis	400 ~ 900 Ω
	Y Axis	200 ~ 500 Ω
Insulating Resistance	DC 25 V	More than 10MΩ
Linearity	--	±1.5 %
Notes life by Pen	Note a	100,000 times(min)
Input life by finger	Note b	1,000,000 times (min)

Note A .

Notes area for pen notes life test is 10 x 9 mm.

Size of word is 7.5 x 6.72

Shape of pen end : R0.8

Load : 250 g

Note B

By Silicon rubber tapping at same point

Shape of rubber end : R8

Load : 200g

Frequency : 5 Hz

Interface

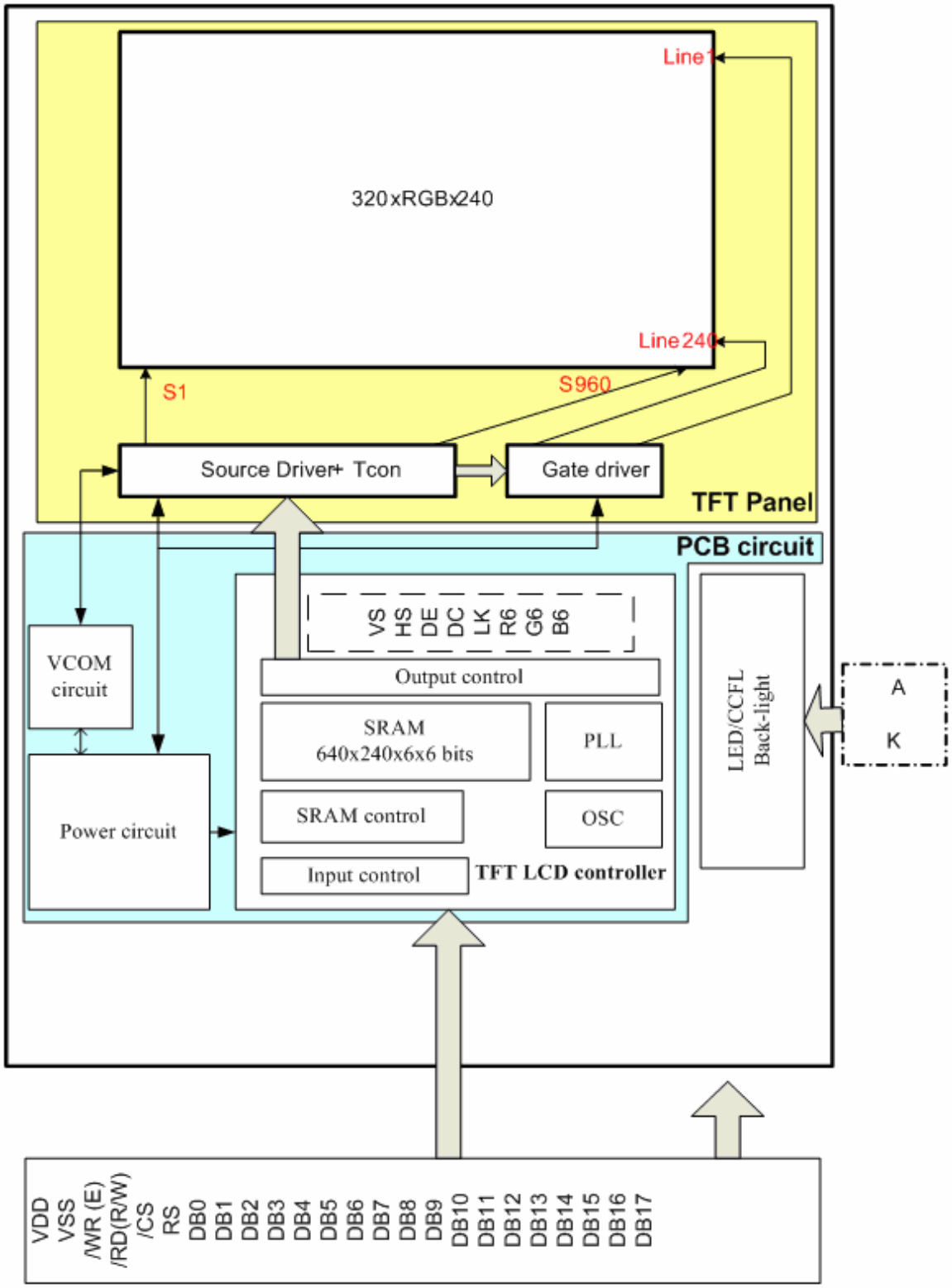
No.	Symbol	Function
1	XR	Touch Panel Right Signal in X Axis
2	YU	Touch Panel Upper Signal in Y Axis
3	XL	Touch Panel Left Signal in X Axis
4	YL	Touch Panel Low Signal in Y Axis

6 Interface specifications

6.1 Driving signals for the TFT panel

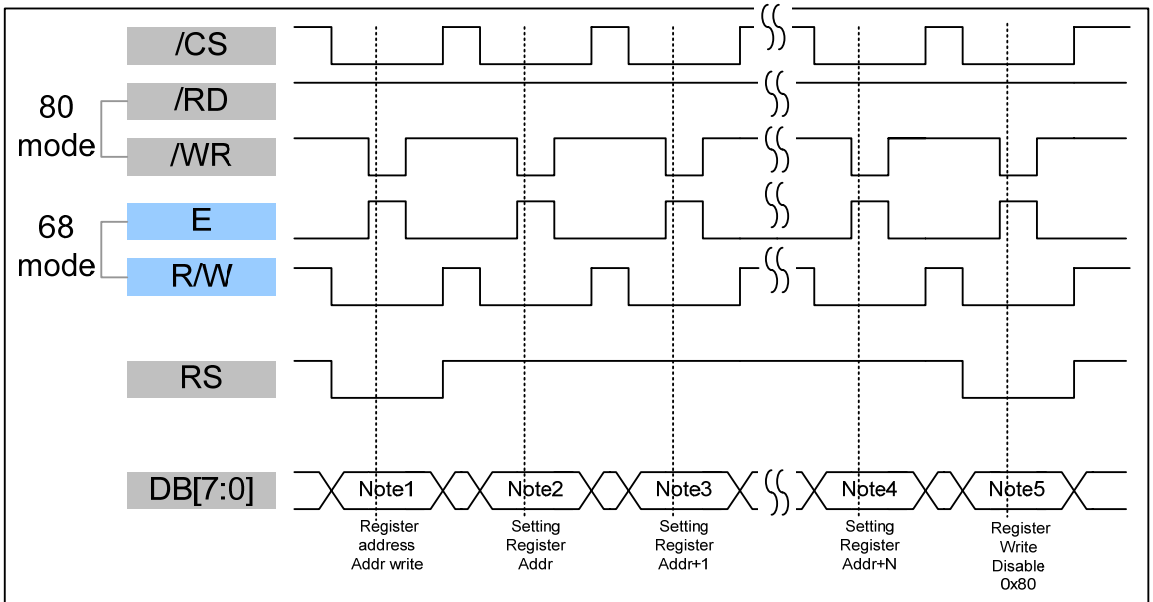
Pin no	Symbol	I/O	Description	Remark
1	/RESET	I	Reset Signal	
2	/WR	I	80 Series: Write Signal 68 Series: R/W Signal	
3	/CS	I	Chip Select Signal	
4	RS	I	Data type selection	
5	RD	II	80 Series: Read signal 68 Series: Enable signal(E)	
6	D0	I/O	Data input/output	
7	D1	I/O		
8	D2	I/O		
9	D3	I/O		
10	D4	I/O		
11	D5	I/O		
12	D6	I/O		
13	D7	I/O		
14	DGND	I	Ground	
15	D8	I/O	Data input/output	
16	D9	I/O		
17	D10	I/O		
18	D11	I/O		
19	D12	I/O		
20	D13	I/O		
21	D14	I/O		
22	D15	I/O		
23	D16	I/O		
24	D17	I/O		
25	VDD	P	Power Supply for Logic	
26	VDD	P		
27	DGND	P	Ground	
28	DGND	P		
29	65K/262K	I	When use 8 or 16 bit MPU interface. The 65k/262k data format can be select. Lo:65K Hi:262K colors When use 9 or 18bit MPU interface. The 262K data can be used only. The 65K/262K pin must set to Hi	
30	DGND	P	Ground	
31	NC		Not use	
32	NC		Not use	
33	NC		Not use	

7 BLOCK DIAGRAM



8 Interface Protocol

8.1 8Bit-80/68- Write to Command Register



Note1: DB[7:0] represent the the Register address Addr.

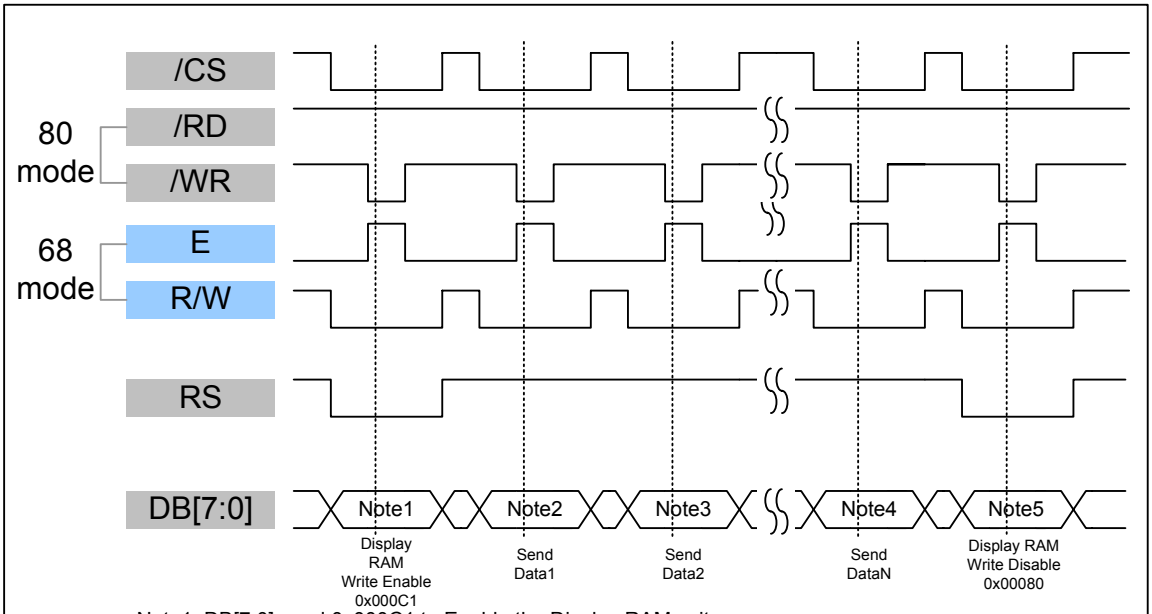
Note2: DB[7:0] represent the the setting value of the Addr.

Note3: DB[7:0] represent the the setting value of the Addr+1.

Note4: DB[7:0] represent the the setting value of the Addr+N.

Note5: DB[7:0] send 0x80 to Disable the Register write.

8.2 8Bit-80/68-Write to Display RAM



Note1: DB[7:0] send 0x000C1 to Enable the Display RAM write.

Note2: DB[7:0] represent the writing Data1 to Display RAM

Note3: DB[7:0] represent the writing Data2 to Display RAM

Note4: DB[7:0] represent the writing DataN to Display RAM

Note5: DB[7:0] send 0x00080 to Disable the Display RAM write.

8.3 Data transfer order Setting

8.3.1 8 bit interface 65K color (JP2 1,2 short 65K/262K =Low)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1st data	X	X	X	X	X	X	X	X	R4	R3	R2	R1	R0	G5	G4	G3
2nd data	X	X	X	X	X	X	X	X	G2	G1	G0	B4	B3	B2	B1	B0

8.3.2 8 bit interface 262K color (JP2 2,3 short 65K/262K =High)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1st data	X	X	X	X	X	X	X	X							R5	R4
2nd data	X	X	X	X	X	X	X	X	R3	R2	R1	R0	G5	G4	G3	G2
3rd data	X	X	X	X	X	X	X	X	G1	G0	B5	B4	B3	B2	B1	B0

9 Register Depiction

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
00	00	MSB of X-axis start position								
Description	set the horizontals start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
01	00	LSB of X-axis start position								
Description	set the horizontals start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
02	01	MSB of X-axis end position								
Description	set the horizontals end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
03	3F	LSB of X-axis end position								
Description	set the horizontals end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
04	00	MSB of Y-axis start position								
Description	set the vertical start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
05	00	LSB of Y-axis start position								
Description	Set the vertical start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
06	00	MSB of Y-axis end position								
Description	set the vertical end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
07	EF	LSB of Y-axis end position								
Description	Set the vertical end position of display active region									

To simplify the address control of display RAM access, the window area address function allows for writing data only within a window area of display RAM specified by registers REG[00]~REG[07] .

After writing data to the display RAM, the Address counter will be increased within

setting window address-range which is specified by

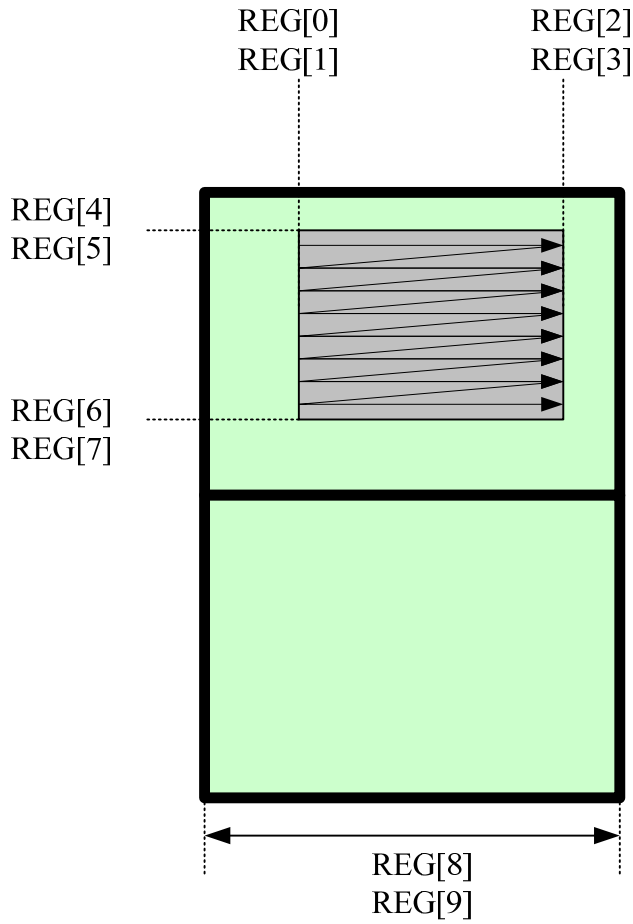
MIN X address (REG[0] & REG[1])

MAX X address (REG[2] & REG[3])

MIN Y address (REG[4] & REG[5])

MAX Y address (REG[6] & REG[7])

Therefore, data can be written consecutively without thinking the data address.



Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
08	01	X	X	X	X	X	X	_PanelXSize H_Byte[1:0]		
Description	Set the panel X size									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
09	40	_PanelXSize L_Byte[7:0]								
Description	Set the panel X size									

The register REG[08] and REG[09] is use to calculate the RAM address. If you want to use the TFT as Landscape mode (320x240), the REG[08] & RGE[09 must set to 320. If you want to use the TFT as Portrait mode (240x320), the REG[08] & RGE[09] must set to 240.

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0A	00	X	X	X	X	X	[17:16] bits of memory write start address			
Description	Memory write start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0B	00	[15:8] bits of memory write start address								
Description	Memory write start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0C	00	[7:0] bits of memory write start address								
Description	Memory write start address									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x10	0x0D	Bit_SWAP	OUT_TEST	BUS_SEL		Blanking	P/S_SEL	CLK_SEL		
Description	"0x10_Clk_sel[1:0]" : The TFT controller built-in 40Mhz PLL clock. These bits are for select the TFT panel dot clock frequency. 00 : 20Mhz 01: 10Mhz 02: 5 Mhz									
	"0x10_ps_sel[2]" : The TFT controller support parallel and serial RGB interface. These bits are for select the output timing. 0 : serial Panel 1: Parallel panel									
	"0x10_blanking_tmp[3]" 0 : OFF (blanking) 1: ON (normal operation)									
	"0x10_bus_sel[5:4]" : It only for serial Panel 00=R , 01=G , 10=B									
	"0x10_out_test[6]" : Self test 0 : normal operation 1: for test (don't use for normal operation) When set the bit to "1" , the Rout=(Reg 2a[6:0]) Gout=(Reg 2b[6:0]) Bout=(Reg 2c[6:0])									
	"0x10_bit_swap[7]" : 0-normal									
	The default setting is suitable for AM320240N1. Don't need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x11	00	X	X	EVEN			_ODD			
Description	" Even line of serial panel data out sequence or data bus order of parallel panel 000: RGB 001: RBG 010: GRB 011: GBR 100: BRG 101: BGR Others: reserved Odd line of serial panel data out sequence 000: RGB 001: RBG 010: GRB 011: GBR 100: BRG **101: BGR** Others: reserved **Must Set to 0x05 for AM320240N1**									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x12	00					Hsync_stH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x13	00	Hsync_stL_Byte[7:0]								
Description	For TFT output timing adjust: Hsync start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x14	00					Hsync_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x15	10	Hsync_pwL_Byte[7:0]								

Description	For TFT output timing adjust: Hsync pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x16	00					Hact_stH_Byte[3:0]				
Description	For TFT output timing adjust: DE pulse start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x17	38	Hact_stL_Byte[7:0]								
Description	For TFT output timing adjust: DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x18	01					Hact_pwH_Byte[3:0]				
Description	For TFT output timing adjust: DE pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x19	40	Hact_pwL_Byte[7:0]								
Description	For TFT output timing adjust: DE pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1A	01					HtotalH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync total clocks H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1B	B8	HtotalL_Byte[7:0]								
Description	For TFT output timing adjust: Hsync total clocks H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1C	00					Vsync_stH_Byte[3:0]				
Description	For TFT output timing adjust: Vsync start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1D	00	Vsync_stL_Byte[7:0]								
Description	For TFT output timing adjust: Vsync start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1E	00					Vsync_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Vsync pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1F	08	Vsync_pwL_Byte[7:0]								
Description	For TFT output timing adjust: Vsync pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x20	00					Vact_stH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical DE pulse start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x21	12	Vact_stL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x22	00					Vact_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical Active width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

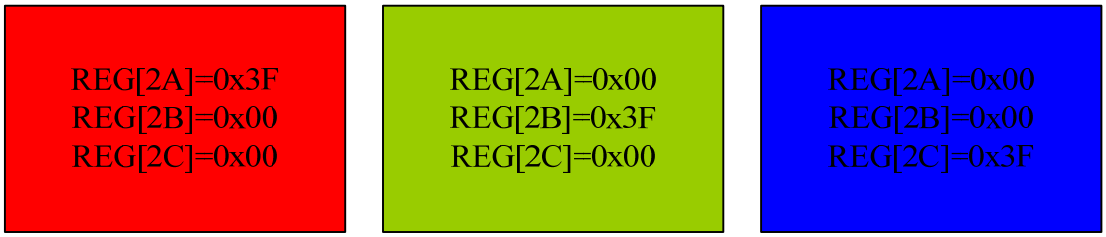
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x23	F0	Vact_pwL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical Active width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x24	01					VtotalH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical total width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x25	09	VtotalL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical total width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
26	00	X	X	X	X	X	[17:16] bits of memory read start address			
Description	Memory read start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
27	00	[15:8] bits of memory write start address								
Description	Memory read start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
28	00	[7:0] bits of memory write start address								
Description	Memory read start address									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
29	00	[7:1] Reversed								
Description	[0] Load output timing related setting (H sync., V sync. and DE) to take effect									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2A	00	X	TestPatternRout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Rout data equal to TestPatternRout[6:0]									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2B	00	X	TestPatternGout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Gout data equal to TestPatternGout[6:0]									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2C	00	X	TestPatternBout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Bout data equal to TestPatternBout[6:0]									

If you set the " REG[0x10]_out_test[6]" : Self test =1 , the TFT controller will skip the connect of the display RAM. The Output port will send the REG[2A] ,REG[2B],REG[2C] data.



Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2D	00	X	X	X	X	[3]	Rising/falling edge[2]	_rotate [1:0]		
Description	[3] Output pin X_DCON level control ; TFT Power ON/OFF control 0: TFT POWER circuit OFF 1: TFT POWER circuit ON									
	Rising/falling edge[2] : 0: The RGB out put data are on the Rising edge of the DCLK. 1: The RGB out put data are on the Falling edge of the DCLK.									
	_rotate [1:0]: 00 : rotate 0 degree 01 : rotate90 degree 10 : rotate 270 degree 11 : rotate 180 degree									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
30	00	X	X	X	X	X	_H byte H-Offset[3:0]			
Description	Set the Horizontal offset									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
31	00	_L byte H-Offset[7:0]								
Description	Set the Horizontal offset									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
32	00	X	X	X	X	X	_H byte V-Offset[3:0]			
Description	Set the Vertical offset									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
33	00	_L byte V-Offset[7:0]								
Description	Set the Vertical offset									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
34	00	[7:4] Reserved					_H byte H-def[3:0]			
Description	[3:0] MSB of image horizontal physical resolution in memory									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
35	40	_L byte H-def[7:0]								
Description	[7:0] LSB of image horizontal physical resolution in memory									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
36	01	[7:4] Reserved					_H byte V-def[3:0]			
Description	[3:0] MSB of image vertical physical resolution in memory									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
37	E0	_L byte V-def[7:0]								
Description	[7:0] LSB of image vertical physical resolution in memory									

The total RAM size is 640x240x18bit. The user can arrange the Horizontal ram size by REG[34],REG[35] and the Vertical ram size by REG[36],REG[37].
EX: 320x480x18bit REG[34]=0x01 , REG[35]=0x40 , REG[36]=0x01 , REG[37]=0xE0
EX: 640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 , REG[37]=0xF0

10 Application Note:

```
void    main(void)
{
   Initial_AMP506 ( );
   Full_386SCR(0xf800);
   Full_386SCR(0x07e0);
   Full_386SCR(0x001f);
}

void AMP506_80Mode_Command_SendAddress(BYTE Addr)
{
   SET_nRD;                    // /RD=1
   CLR_RS;                     // RS=0
   CLR_CS1;                    // /CS=0
   CLR_nWRL;                   // /WR=0
   DB16OUT(Addr);              // Data Bus OUT
   SET_nWRL;                   ///WR=1        /
   SET_RS;                     // RS=1
   SET_CS1;                    // CS=1
  }
```

```
void AMP506_80Mode_Command_SendData(BYTE Data)
{
   SET_nRD;
   SET_RS;
   CLR_CS1;
   CLR_nWRL;
   DB16OUT(Data);
   SET_nWRL;
   SET_RS;
   SET_CS1;
 }

void AMP506_Command_Write(uint8 CMD_Address,uint8 CMD_Value)
{
   AMP506_80Mode_Command_SendAddress(CMD_Address);
   AMP506_80Mode_Command_SendData(CMD_Value);
}



void AMP506_80Mode_16Bit_Memory_SendData(uint16 Dat16bit)
{
   SET_nRD;
   SET_RS;
   CLR_CS1;
   CLR_nWRL;
   DB16OUT(Dat16bit>>8);
   SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_CS1;

   SET_nRD;
   SET_RS;
   CLR_CS1;
   CLR_nWRL;
   DB16OUT(Dat16bit);
   SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_CS1;

}
```

```
void Initial_AMP506(void)
{
   AMP506_Command_Write(0x40,0x12);       /*[7:6] Reserved
                                            [5] PLL control pins to select out frequency range
                                            0: 20MHz ~ 100MHz 1: 100MHz ~ 300MHz
                                            [4] Reserved [3] Reserved
                                            [2:1] Output Driving Capability
                                            00: 4mA    01: 8mA    10: 12mA    11: 16mA
                                            [0] Output slew rate
                                            0: Fast 1: Slow
                                           */
AMP506_Command_Write(0x41,0x01);          //Set PLL=40Mhz * (0x42) / (0x41)
AMP506_Command_Write(0x42,0x01);          //0x41 [7:6] Reserved [5:0] PLL Programmable pre-divider,
                                            6bit(1~63)
                                           //0x42 [7:6] Reserved [5:0] PLL Programmable loop
                                            divider, 6bit(1~63)
AMP506_Command_Write(0x00,0x00);       // MSB of horizontal start coordinate value
AMP506_Command_Write(0x01,0x00);       // LSB of horizontal start coordinate value
AMP506_Command_Write(0x02,0x01);       // MSB of horizontal end coordinate value
AMP506_Command_Write(0x03,0x3F);       // LSB of horizontal end coordinate value
            AMP506_Command_Write(0x04,0x00);       // MSB of vertical start coordinate value
            AMP506_Command_Write(0x05,0x00);       // LSB of vertical start coordinate value
            AMP506_Command_Write(0x06,0x01);       // MSB of vertical end coordinate value
            AMP506_Command_Write(0x07,0x3F);       // LSB of vertical end coordinate value

            AMP506_Command_Write(0x08,0x01);  // MSB of input image horizontal resolution
            AMP506_Command_Write(0x09,0x40);  // LSB of input image horizontal resolution
            AMP506_Command_Write(0x0a,0x00);  //[17:16] bits of memory write start address
            AMP506_Command_Write(0x0b,0x00);  //[15:8] bits of memory write start address
            AMP506_Command_Write(0x0c,0x00);  //[7:0] bits of memory write start address

AMP506_Command_Write(0x10,0x0D);   /*[7] Output data bits swap      0: Normal 1:Swap
                                     [6] Output test mode enable 0: disable 1: enable
                                     [5:4] Serial mode data out bus selection
                                     00: X_ODATA17 ~ X_ODATA12 active , others are set to zero
                                     01: X_ODATA11 ~ X_ODATA06 active , others are set to zero
                                     10: X_ODATA05 ~ X_ODATA00 active , others are set to zero
```

```
                                    11: reserved
                                    [3] Output data blanking
                                    0: set output data to 0      1: Normal display
                                   [2] Parallel or serial mode selection
                                    0: serial data out           1: parallel data output
                                   [1:0] Output clock selection
                                   00: system clock divided by 2
                                   01: system clock divided by 4
                                   10: system clock divided by 8
                                   11: reserved */
      AMP506_Command_Write(0x11,0x05);
  /*[7] Reserved
     [6:4] Even line of serial panel data out sequence or data bus order of parallel panel
     000: RGB     001: RBG     010: GRB     011: GBR    100: BRG    101: BGR     Others: reserved
     [3] Reversed
     [2:0] Odd line of serial panel data out sequence
     000: RGB     001: RBG     010: GRB     011: GBR    100: BRG    101: BGR     Others: reserved
  */
    AMP506_Command_Write(0x12,0x00);     // [3:0] MSB of output H sync. pulse start position
    AMP506_Command_Write(0x13,0x00);     //[7:0] LSB of output H sync. pulse start position
    AMP506_Command_Write(0x14,0x00);     // [3:0] MSB of output H sync. pulse width

      AMP506_Command_Write(0x15,0x10);       //[7:0] LSB of output H sync. pulse width
      AMP506_Command_Write(0x16,0x00);       //[3:0] MSB of output DE horizontal start position
      AMP506_Command_Write(0x17,0x38);       //[7:0] LSB of output DE horizontal start position

  AMP506_Command_Write(0x18,0x01);   //[3:0] MSB of output DE horizontal active region in pixel
  AMP506_Command_Write(0x19,0x40);   //[7:0] LSB of output DE horizontal active region in pixel
  AMP506_Command_Write(0x1a,0x01);   //[7:4] Reserved [3:0] MSB of output H total in pixel
  AMP506_Command_Write(0x1b,0xb8);   //[7:0] LSB of output H total in pixel
  AMP506_Command_Write(0x1c,0x00);     //[3:0] MSB of output V sync. pulse start position
  AMP506_Command_Write(0x1d,0x00);     //[7:0] of output V sync. pulse start position
  AMP506_Command_Write(0x1e,0x00);     //[7:4] Reserved [3:0] MSB of output V sync. pulse width
  AMP506_Command_Write(0x1f,0x08);     //[7:0] LSB of output V sync. pulse width
  AMP506_Command_Write(0x20,0x00);     // [3:0] MSB of output DE vertical start position
  AMP506_Command_Write(0x21,0x12);     //[7:0] LSB of output DE vertical start position
  AMP506_Command_Write(0x22,0x00);     // [3:0] MSB of output DE vertical active region in line
  AMP506_Command_Write(0x23,0xf0);     //[7:0] LSB of output DE vertical active region in line
```

```
        AMP506_Command_Write(0x24,0x01);      //[7:4] Reversed [3:0] MSB of output V total in line
        AMP506_Command_Write(0x25,0x09);      //[7:0] LSB of output V total in line
        AMP506_Command_Write(0x26,0x00);      // [17:16] bits of memory read start address
        AMP506_Command_Write(0x27,0x00);      //[7:0] [15:8] bits of memory read start address
        AMP506_Command_Write(0x28,0x00);      //[7:0] [7:0] bits of memory read start address
       AMP506_Command_Write(0x29,0x01);
      //[7:1] Reversed [0] Load output timing related setting (H sync., V sync. and DE) to take effect
     AMP506_Command_Write(0x2d,0x08);      /* [7:4] Reserved
                                              [3] Output pin X_DCON level control
                                              [2] Output clock inversion    0: Normal 1: Inverse
                                              [1:0] Image rotate
                                                00: 0°    01: 90°    10: 270° 11: 180°
                                             */
     AMP506_Command_Write(0x30,0x00);       //[7:4] Reserved [3:0] MSB of image horizontal shift value
     AMP506_Command_Write(0x31,0x00);       //[7:0] LSB of image horizontal shift value
     AMP506_Command_Write(0x32,0x00);       //[7:4] Reserved [3:0] MSB of image vertical shift value
     AMP506_Command_Write(0x33,0x00);       //[7:0] LSB of image vertical shift value
     AMP506_Command_Write(0x34,0x01);
    // [3:0] MSB of image horizontal physical Resolution in memory
     AMP506_Command_Write(0x35,0x40);
     //[7:0] LSB of image horizontal physical resolution in memory

          AMP506_Command_Write(0x36,0x01);
//[7:4] Reserved [3:0] MSB of image vertical physical resolution in memory
          AMP506_Command_Write(0x37,0xe0);
//[7:0] LSB of image vertical physical resolution in memory
}


void AMP506_WindowSet(uint16 S_X,uint16 S_Y,uint16 E_X,uint16 E_Y)
{
                AMP506_80Mode_Command_SendAddress(0x00);
                AMP506_80Mode_Command_SendData((S_X)>>8);
                AMP506_80Mode_Command_SendData(S_X);
                AMP506_80Mode_Command_SendData((E_X-1)>>8);
                AMP506_80Mode_Command_SendData(E_X-1);
                AMP506_80Mode_Command_SendData(S_Y>>8);
                AMP506_80Mode_Command_SendData(S_Y);
```

```
                AMP506_80Mode_Command_SendData((E_Y-1)>>8);
                AMP506_80Mode_Command_SendData(E_Y-1);
}

void Full_386SCR(uint16 Dat16bit)
{
   int32 k,l;
   AMP506_WindowSet(0,0,Resolution_X,Resolution_Y);
   AMP506_80Mode_Command_SendAddress(0xc1);    //_DisplayRAM_WriteEnable_
 for(k=0;k<240*2;k++)
    {
      for(l=0;l<320;l++)
        {
            AMP506_80Mode_16Bit_Memory_SendData(Dat16bit);
         }
    }
   AMP506_80Mode_Command_SendAddress(0x80);    // DisplayRAM_WriteDisable _

}
```

The TFT LCD controller default value is for AM320240NS already. So we can start to write our data in a few steps:

Target: To write a 640x240 data to Display RAM and scroll the display data by change the Horizontal offset register.

10.1 Step 1: Make sure the interface Protocol.

10.2 Step 2: Define the Horizontal ram seize = 640 and Vertical ram size =240 640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 , REG[37]=0xF0

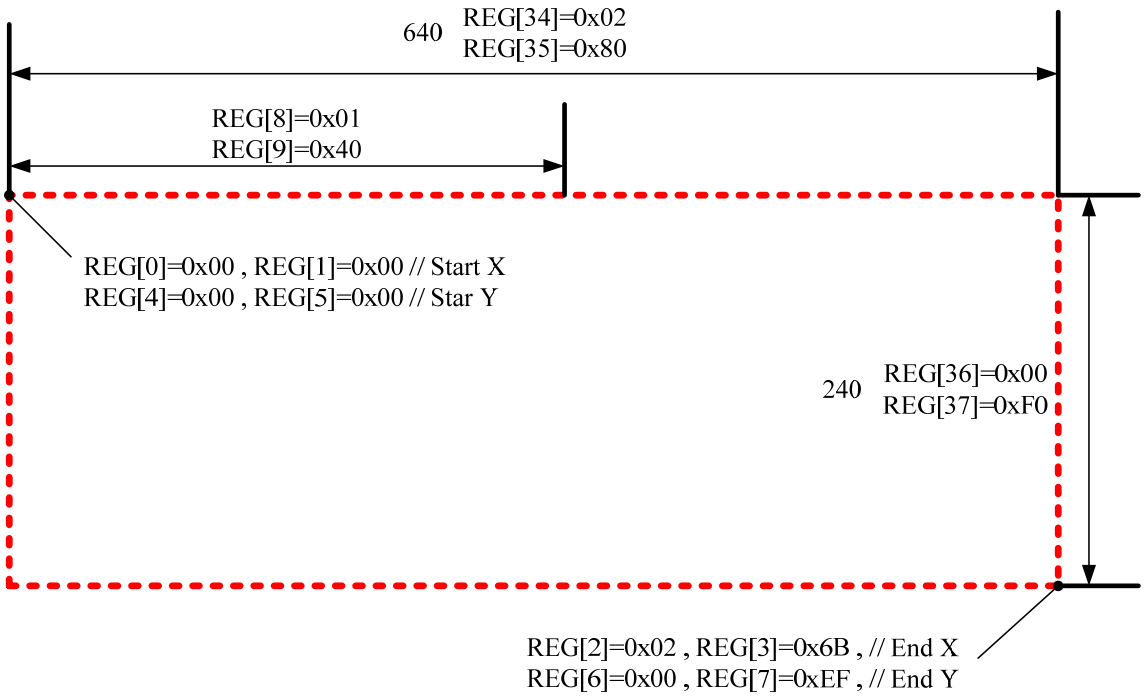
10.3 Step 3: Define the Panel X Size = 320

REG[8]=0x01 , REG[9]=0x40

10.4 Step4: Define the Write window. Start=(0,0) End=(619,239)

REG[0]=0x00 , REG[1]=0x00 , REG[2]=0x02 , REG[3]=0x6B , // Start X , End X

REG[4]=0x00 , REG[5]=0x00 , REG[6]=0x00 , REG[7]=0xEF , // Star Y ,End Y



10.5 Step5: Write the 640x240x18 bit data consecutively

10.6 Step6: The display will show the following image.

10.7 Step7: Change the Horizontal offset to switch or scroll the display data.

Set the Horizontal offset = 160 , REG[30]=00 REG[31]=A0 . You will see

10.8 Step8: Change the Horizontal offset to switch or scroll the display data.

Set the Horizontal offset = 320 , REG[30]=01 REG[31]=40 . You will see

DISPLAYED COLOR AND INPUT DATA

	Color & Gray Scale	DATA SIGNAL																	
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Red	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(61)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(31)	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(1)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Green	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(62)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(61)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(31)	0	0	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(1)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(0)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Blue	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(61)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(31)	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

11 QUALITY AND RELIABILITY

11.1 TEST CONDITIONS

Tests should be conducted under the following conditions :
Ambient temperature : 25 ± 5°C
Humidity : 60 ± 25% RH.

11.2 SAMPLING PLAN

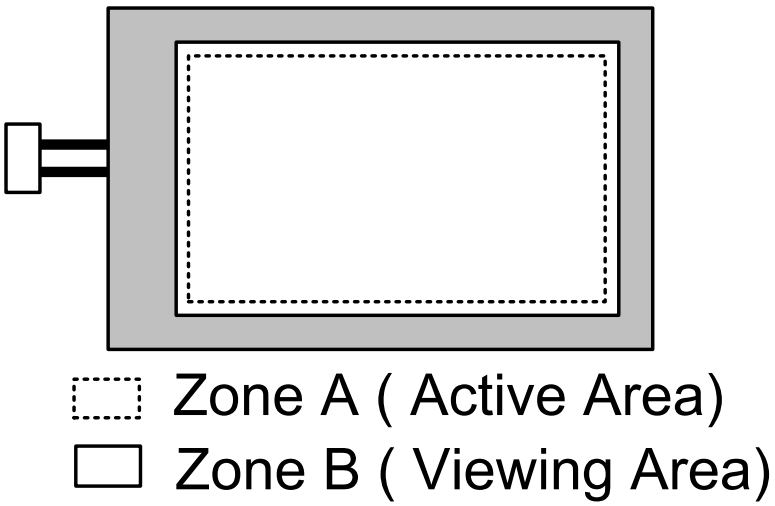
Sampling method shall be in accordance with MIL-STD-105E , level II, normal single sampling plan .

11.3 ACCEPTABLE QUALITY LEVEL

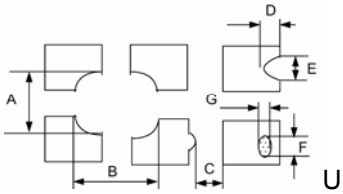
A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

11.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.

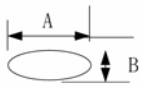


11.5 INSPECTION QUALITY CRITERIA

<table>
<tr><th>No.</th><th>Item</th><th>Criterion for defects</th><th>Defect type</th></tr>
<tr><td>1</td><td>Non display</td><td>No non display is allowed</td><td>Major</td></tr>
<tr><td>2</td><td>Irregular operation</td><td>No irregular operation is allowed</td><td>Major</td></tr>
<tr><td>3</td><td>Short</td><td>No short are allowed</td><td>Major</td></tr>
<tr><td>4</td><td>Open</td><td>Any segments or common patterns that don’t activate are rejectable.</td><td>Major</td></tr>
<tr><td>5</td><td>Black/White spot (I)</td><td><table><tr><th>Size D (mm)</th><th>Acceptable number</th></tr><tr><td>D ≤ 0.15</td><td>Ignore</td></tr><tr><td>0.15 < D ≤ 0.20</td><td>3</td></tr><tr><td>0.20 < D ≤ 0.30</td><td>2</td></tr><tr><td>0.30 < D</td><td>0</td></tr></table></td><td>Minor</td></tr>
<tr><td>6</td><td>Black/White line (I)</td><td><table><tr><th>Length(mm)</th><th></th><th>Acceptable number</th></tr><tr><td>10 < L</td><td>0.03 < W ≤ 0.04</td><td>5</td></tr><tr><td>5.0 < L ≤10</td><td>0.04 < W ≤ 0.06</td><td>3</td></tr><tr><td>1.0 < L ≤ 5.0</td><td>0.06 < W ≤ 0.07</td><td>2</td></tr><tr><td>L ≤ 1.0</td><td>0.07 < W ≤ 0.09</td><td>1</td></tr></table></td><td>Minor</td></tr>
<tr><td>7</td><td>Black/White sport (II)</td><td><table><tr><th>Size D (mm)</th><th>Acceptable number</th></tr><tr><td>D ≤ 0.30</td><td>Ignore</td></tr><tr><td>0.30 < D ≤ 0.50</td><td>5</td></tr><tr><td>0.50 < D ≤ 1.20</td><td>3</td></tr><tr><td>1.20 < D</td><td>0</td></tr></table></td><td>Minor</td></tr>
<tr><td>8</td><td>Black/White line (II)</td><td><table><tr><th>Length (mm)</th><th>Width (mm)</th><th>Acceptable number</th></tr><tr><td>20 < L</td><td>0.05 < W ≤ 0.07</td><td>5</td></tr><tr><td>10 < L ≤ 20</td><td>0.07 < W ≤ 0.09</td><td>3</td></tr><tr><td>5.0 < L ≤ 10</td><td>0.09 < W ≤ 0.10</td><td>2</td></tr><tr><td>L ≤ 5.0</td><td>0.10 < W ≤ 0.15</td><td>1</td></tr></table></td><td>Minor</td></tr>
<tr><td>9</td><td>Back Light</td><td>1. No Lighting is rejectable
2. Flickering and abnormal lighting are rejectable</td><td>Major</td></tr>
<tr><td>10</td><td>Display pattern</td><td> 

Unit:mm
<table><tr><td>$\frac{A+B}{2} \le 0.30$</td><td>0 < C</td><td>$\frac{D+E}{2} \le 0.25$</td><td>$\frac{F+G}{2} \le 0.25$</td></tr></table>
Note: 1. Acceptable up to 3 damages
2. NG if there’re to two or more pinholes per dot</td><td>Minor</td></tr>
</table>

<table>
<tr><td>11</td><td>Blemish & Foreign matters

Size:
$D=\frac{A+B}{2}$</td><td><table><tr><th>Size D (mm)</th><th>Acceptable number</th></tr><tr><td>D ≤ 0.15</td><td>Ignore</td></tr><tr><td>0.15 < D ≤ 0.20</td><td>3</td></tr><tr><td>0.20 < D ≤ 0.30</td><td>2</td></tr><tr><td>0.30 < D</td><td>0</td></tr></table></td><td>Minor</td></tr>
<tr><td>12</td><td>Scratch on Polarizer
  </td><td><table><tr><th>Width (mm)</th><th>Length (mm)</th><th>Acceptable number</th></tr><tr><td>W≤0.03</td><td>Ignore</td><td>Ignore</td></tr><tr><td>0.03<W≤0.05</td><td>L ≤ 2.0</td><td>Ignore</td></tr><tr><td></td><td>L > 2.0</td><td>1</td></tr><tr><td>0.05<W≤0.08</td><td>L > 1.0</td><td>1</td></tr><tr><td></td><td>L ≤ 1.0</td><td>Ignore</td></tr><tr><td>0.08<W</td><td>Note (1)</td><td>Note(1)</td></tr></table>Note(1) Regard as a blemish</td><td>Minor</td></tr>
<tr><td>13</td><td>Bubble in polarizer</td><td><table><tr><th>Size D (mm)</th><th>Acceptable number</th></tr><tr><td>D ≤ 0.20</td><td>Ignore</td></tr><tr><td>0.20 < D ≤ 0.50</td><td>3</td></tr><tr><td>0.50 < D ≤ 0.80</td><td>2</td></tr><tr><td>0.80 < D</td><td>0</td></tr></table></td><td>Minor</td></tr>
<tr><td>14</td><td>Stains on LCD panel surface</td><td>Stains that cannot be removed even when wiped lightly with a soft cloth or similar cleaning too are rejectable.</td><td>Minor</td></tr>
<tr><td>15</td><td>Rust in Bezel</td><td>Rust which is visible in the bezel is rejectable.</td><td>Minor</td></tr>
<tr><td>16</td><td>Defect of land surface contact (poor soldering)</td><td>Evident crevices which is visible are rejectable.</td><td>Minor</td></tr>
<tr><td>17</td><td>Parts mounting</td><td>1. Failure to mount parts
2. Parts not in the specifications are mounted
3. Polarity, for example, is reversed</td><td>Major
Major
Major</td></tr>
<tr><td>18</td><td>Parts alignment</td><td>1. LSI, IC lead width is more than 50% beyond pad outline.
2. Chip component is off center and more than 50% of the leads is off the pad outline.</td><td>Minor
Minor</td></tr>
<tr><td>19</td><td>Conductive foreign matter (Solder ball, Solder chips)</td><td>1. 0.45< φ ,N≧1
2. 0.30< φ ≤0.45 ,N≧1
φ :Average diameter of solder ball (unit: mm)
3. 0.50<L ,N≧1
L: Average length of solder chip (unit: mm)</td><td>Major
Minor
Minor</td></tr>
<tr><td>20</td><td>Faulty PCB correction</td><td>1. Due to PCB copper foil pattern burnout, the pattern is connected, using a jumper wire for repair; 2 or more places are corrected per PCB.
2. Short circuited part is cut, and no resist coating has been performed.</td><td>Minor
Minor</td></tr>
</table>

<table>
<tr><td>21</td><td>Defect Dot</td><td>The TFT panel may have bright dot or Dark dot.
The acceptable number defection:<table><tr><th>Bright dot</th><th>Dark dot</th><th>Total dot</th><th>Distance between Dark-- dark</th></tr><tr><td>2</td><td>3</td><td>4</td><td>L≧5 mm</td></tr></table></td><td>Minor</td></tr>
</table>

12 Reliability test items (Note2):

No.	Test items	Conditions	Remark
1	High temperature storage	Ta=80℃ 240Hrs	
2	Low temperature storage	Ta=-30℃ 240Hrs	
3	High temperature operation	Ta=70℃ 240Hrs	
4	Low temperature operation	Ta=-20℃ 240Hrs	
5	High temperature and high humidity	Ta=40℃,85% RH 240Hrs	Operation
6	Heat shock	-30℃~80℃/200 cycles 1Hrs/cycle	Non-operation
7	Electrostatic discharge	±200V,200Pf(0Ω),once for each terminal	Non-operation
8	Vibration	Frequency range :8~33.3Hz Stoke :1.3mm Sweep :2.9G,33.3~400Hz Cycle :15 minutes 2 hours for each direction of X,Z 4 hours for Y direction	JIS C7021, A-10 Condition A
9	Mechanical shock	100G, 6ms,±X, ±Y,±Z 3 times for each direction	JIS C7021, A-7 Condition C
10	Vibration (With carton)	Random vibration: $0.015G^2$/Hz from 5~200Hz -6dB/octave from 200~500Hz	IEC 68~34
11	Drop (with carton)	Height:60cm 1 corner,3 edges,6 surfaces	JIS Z0202

13 USE PRECAUTIONS

13.1 Handling precautions

1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

13.2 Installing precautions

1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. 1MΩ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

13.3 Storage precautions

1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.

3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

13.4 Operating precautions

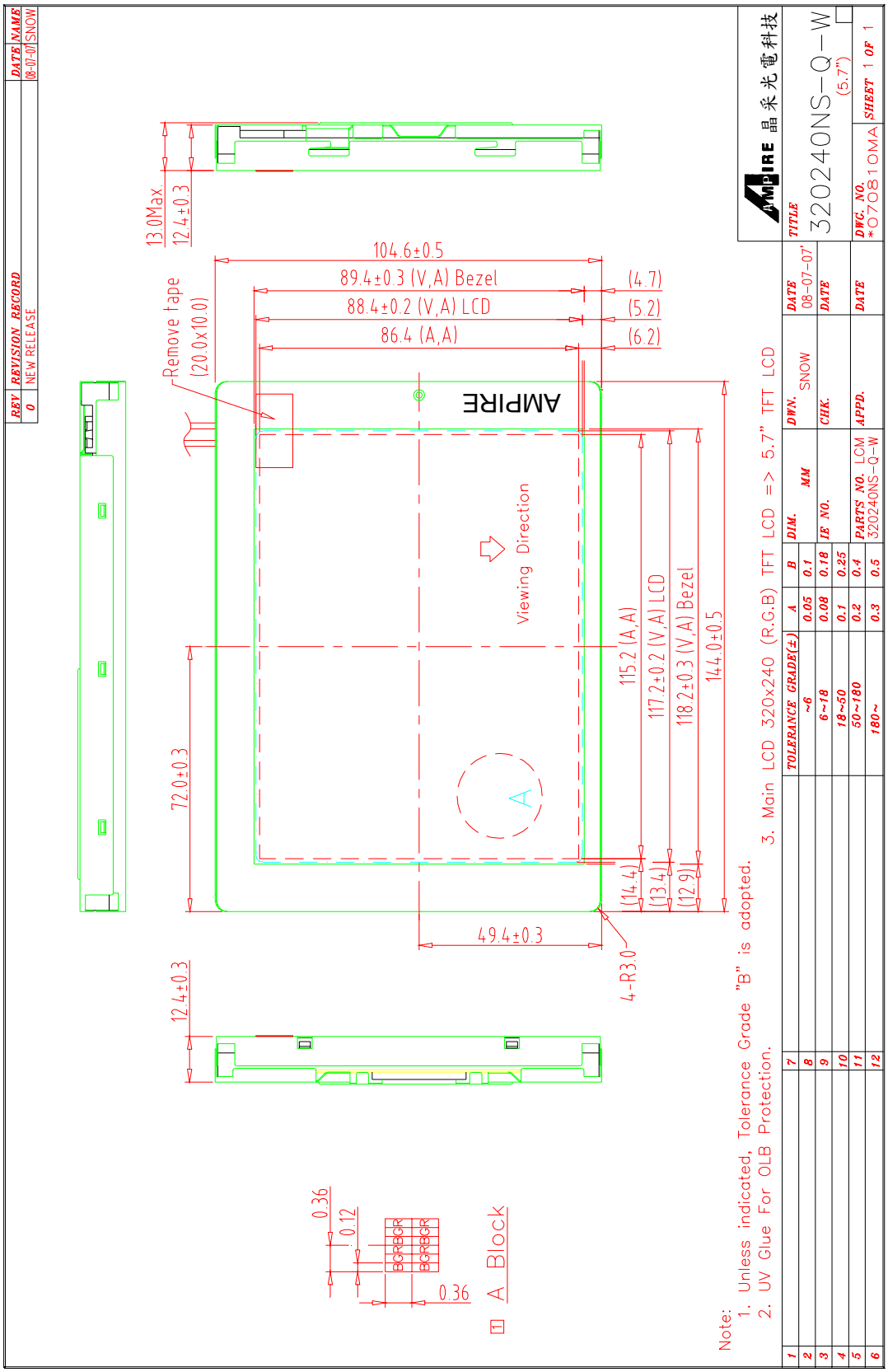
1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

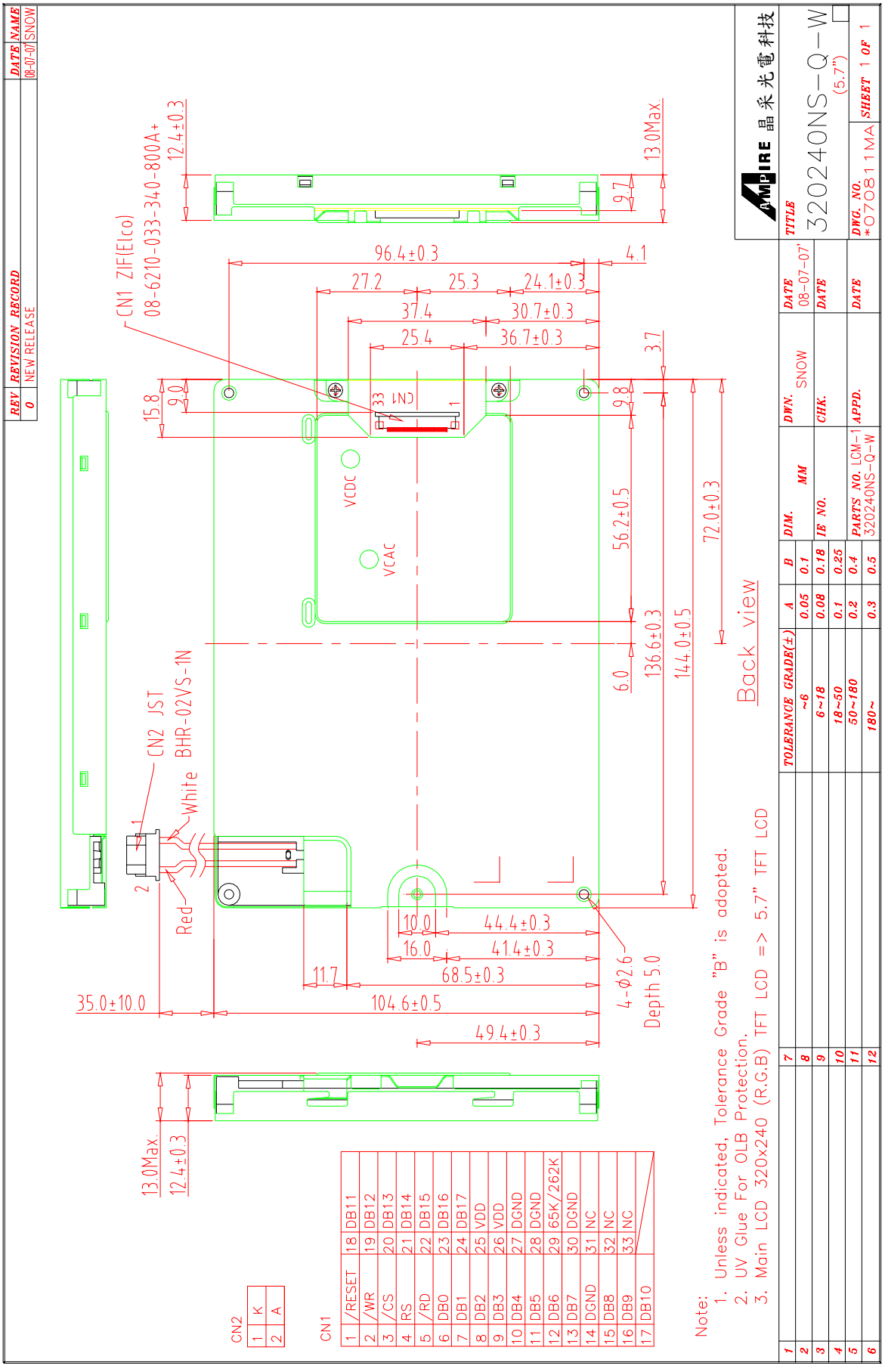
13.5 Other

1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.

14 OUTLINE DIMENSION

14.1 OUTLINE DIMENSION




REV 0 REVISION RECORD NEW RELEASE DATE 08-07-07 NAME SNOW
CN1 ZIF(Elco) 08-6210-033-340-800A+
12.4±0.3
13.0Max.
9.7
96.4±0.3
4.1
27.2
25.3
24.1±0.3
37.4
30.7±0.3
25.4
36.7±0.3
3.7
15.8
9.0
9.8
CN1
VCDC
VCAC
56.2±0.5
72.0±0.3
6.0
136.6±0.3
144.0±0.5
Back view
CN2 JST BHR-02VS-1N
White
Red
10.0
44.4±0.3
16.0
41.4±0.3
11.7
68.5±0.3
35.0±10.0
104.6±0.5
49.4±0.3
4-Φ2.6
Depth 5.0
13.0Max.
12.4±0.3
Note:
1. Unless indicated, Tolerance Grade "B" is adopted.
2. UV Glue For OLB Protection.
3. Main LCD 320x240 (R.G.B) TFT LCD => 5.7" TFT LCD
CN2
1 K
2 A
CN1
1 /RESET 18 DB11
2 /WR 19 DB12
3 /CS 20 DB13
4 RS 21 DB14
5 /RD 22 DB15
6 DB0 23 DB16
7 DB1 24 DB17
8 DB2 25 VDD
9 DB3 26 VDD
10 DB4 27 DGND
11 DB5 28 DGND
12 DB6 29 65K/262K
13 DB7 30 DGND
14 DGND 31 NC
15 DB8 32 NC
16 DB9 33 NC
17 DB10
AMPIRE 晶采光電科技
TITLE 320240NS-Q-W (5.7")
DWG. NO. *0708111MA
SHEET 1 OF 1
DWN. SNOW 08-07-07
CHK.
APPD.
DIM. MM
IE NO.
PARTS NO. LCM-1 320240NS-Q-W
TOLERANCE GRADE(±) A B
~6 0.05 0.1
6~18 0.08 0.18
18~50 0.1 0.25
50~180 0.2 0.4
180~ 0.3 0.5